OLED DISPLAY SPECIFICATION





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REX012864G

General Specification

The features is described as follow:

■ Module Dimension: 60.5 × 37.0 × 2.15 mm

■ Active Area: 55.01 × 27.49mm

Dot Matrix: 128 × 64

■ Dot Size: 0.40 × 0.40 mm

■ Dot Pitch: 0.43 × 0.43 mm

■ Display Mode : Passive Matrix

Duty: 1/64 Duty

Display Color: Monochrome

■ Controller IC: SSD1309

■ Interface: 6800,8080,4-wire SPI,I2C

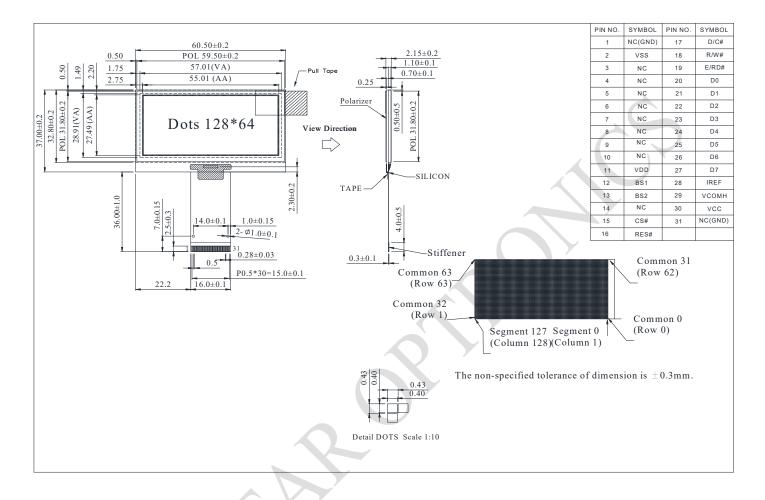
■ Size: 2.42-inch

Interface Pin Function

Pin No.	Symbol	Function					
1	NC(GND)	No connection					
2	VSS	Ground.					
3-10	NC	No connection					
11	VDD	Power supply pin for core logic operation					
		MCU bus interface selection pins. Select appropriate logic setting as					
12	BS1	described in the following table. BS2, BS1 and BS0 are pin select					
		BS1 BS2					
		1 0 1 0					
		4-wire Serial					
		8-bit 80XX Parallel 1 1					
13	BS2	Note					
		(1) 0 is connected to VSS					
		(2) 1 is connected to VDD					
14	NC	No connection					
	CS#	This pin is the chip select input connecting to the MCU.					
15		The chip is enabled for MCU communication only when CS# is pulled					
		LOW (active LOW).					
	4	This pin is reset signal input.					
16	RES#	When the pin is pulled LOW, initialization of the chip is executed.					
		Keep this pin pull HIGH during normal operation.					
		This pin is Data/Command control pin connecting to the MCU.					
Q	When the pin is pulled HIGH, the data at D[7:0] will be interpreted as						
	D/C#	data.					
		When the pin is pulled LOW, the data at D[7:0] will be transferred to a					
17		command register.					
		In I2C mode, this pin acts as SA0 for slave address selection.					
		When 3-wire serial interface is selected, this pin must be connected to					
		VSS.					

		
		This pin is read / write control input pin connecting to the MCU interface. When 6800 interface mode is selected, this pin will be used as
		Read/Write (R/W#) selection input. Read mode will be carried out when this pin is pulled HIGH and write mode when LOW.
18	R/W#	When 8080 interface mode is selected, this pin will be the Write (WR#)
	1000	input. Data write operation is initiated when this pin is pulled LOW and
		the chip is selected.
		When serial or I2C interface is selected, this pin must be connected to
		VSS.
	E/RD#	This pin is MCU interface input.
		When 6800 interface mode is selected, this pin will be used as the
		Enable (E) signal.
		Read/write operation is initiated when this pin is pulled HIGH and the
19		chip is selected.
		When 8080 interface mode is selected, this pin receives the Read (RD#)
		signal. Read operation is initiated when this pin is pulled LOW and the
		chip is selected.
		When serial or I2C interface is selected, this pin must be connected to
		VSS.
		These pins are bi-directional data bus connecting to the MCU data bus. Unused pins are recommended to tie LOW.
	D0~D7	When serial interface mode is selected, D0 will be the serial clock input:
20~27		SCLK; D1 will be the serial data input: SDIN and D2 should be kept NC.
		When I2C mode is selected, D2, D1 should be tied together and serve
		as SDAout,
		SDAin in application and D0 is the serial clock input, SCL.
28	IREF	This pin is the segment output current reference pin.
		IREF is supplied externally.
29	VCOMH	COM signal deselected voltage level.
		A capacitor should be connected between this pin and VSS.
30	VCC	Power supply for panel driving voltage. This is also the most positive
	NO(CNE)	power voltage supply pin.
31	NC(GND)	No connection

Contour Drawing



Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage for Logic	VDD	-0.3	4	V
Supply Voltage for Display	VCC	0	15	V
Operating Temperature	TOP	-40	+80	ပိ
Storage Temperature	TSTG	-40	+85	°C

Electrical Characteristics

DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	-	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	12.5	13	13.5	V
High Level Input	VIH	_	0.8×VDD	—	VDD	V
Low Level Input	VIL	_	0	—	0.2×VDD	V
High Level Output	VOH	_	0.9×VDD	_	VDD	V
Low Level Output	VOL	_	0	_	0.1×VDD	V
50% Check Board Operati Current	VCC =13V	_	18	27	mA	